

GET (3519TT) plans to raise fund by issuance of new shares through private placement

GET's (GET, 3519TT) Board of Directors today (Dec. 12) has adopted a proposal of fund raising by issuance of no more than 39,447 thousand new common shares at NT\$15.21 per share through private placement.

The fund is planned to strengthen GET's financial structure and well prepare to develop new technologies such as diamond wired wafer and black wafer with etching. The first private placement will be subscribed by Tatung Group to show the Group's confidence and support to GET.

GET 2017 private placement

- I. Background information: GET private placement plan has been approved by AGM on June 16, 2017 to raise funds by
 - A. Issuance of no more than 80 million new common shares
 - B. Or issuance of no more than 13,000 convertible bonds (Par Value per CB: NT\$100,000), total amount no more than NT\$ 1.3 billion.
 - C. Use of proceeds: to strengthen financial structure for working capital and long-term operation
 - D. The funds shall be raised within one year starting from AGM approval date (2017/06/16), with one or up to two private placements.

- II. The first private placement plan of 2017:
 - A. Pricing date: Dec. 12 , 2017
 - B. Shares to issue: No more than 39,447 thousand new common shares
(The final shares are subject to the approval by the subscriber's board meeting.)
 - C. Price per share: NT\$ 15.21 per common share (80.01% of reference price per share NT\$ 19.01- the average price of 30-day market price prior to pricing date.)
 - D. Record date: Dec. 22 , 2017
 - E. Subscriber: TATUNG Co., Ltd (2371TT).

Thank you for your attention.